



DB3

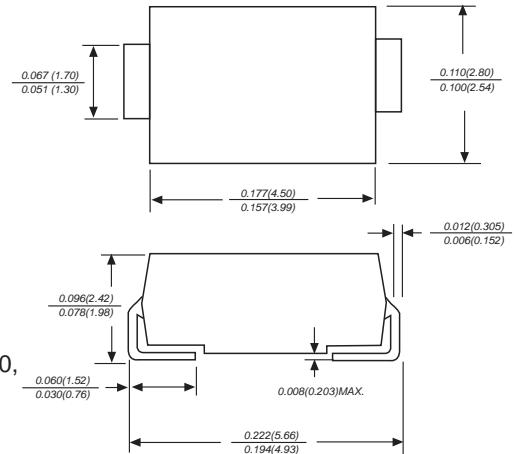
BIDIRECTIONAL TRIGGER DIODE

Reverse Voltage 28- 32 Volts Power: 150mW

FEATURES

The plastic package
VBO:28-36V version
Low breakover current
High temperature soldering guaranteed
250°C/10 seconds,0.375"(9.5mm) lead length,
5 lbs. (2.3kg) tension

DO-214AC



Dimensions in inches and (millimeters)

MAXIMUM RATINGS AND CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified.

	TEST CONDITION	SYMBOLS	VALUE			UNITS
			Min.	Typ.	Max.	
Breakover voltage *	C=22nF **	V _{BO}	28	32	36	VOLTS
Breakover voltage symmetry	C=22nF **	I+V _{BO} -I-V _{BO} I	-3		3	VOLTS
Dynamic breakover voltage *	(NOTE 1)	I Δ V ± I	5			VOLTS
Output voltage *	DIAGRAM2	V _O	5			VOLTS
Breakover current *	C=22nF **	I _{BO}			100	μA
Rise time *	DIAGRAM3	tr		1.5		μS
Leakage current *	V _R =0.5V _{BO}	I _B			10	μA
Power dissipation on printed circuit	T _A =65°C	P _d			150	mW
Repetitive peak on-state current	t _p =20μs f=100Hz	I _{TRM}			2	A
Thermal Resistances from Junction to ambient		R _{θJA}			400	°C/W
Thermal Resistances from Junction to lead		R _{θJL}			150	
Operating junction and storage temperature range		T _{J,T_{STG}}	-40		125	°C

* :Electrical characteristic appoicaboe in forward and reverse directions.

** :Connected in parallel with the devices.

Note 1:I_{BO} from I_{BO} to 10mA



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RATINGS AND CHARACTERISTIC CURVES DB3

DIAGRAM 1: CURRENT-VOLTAGE CHARACTERISTICS

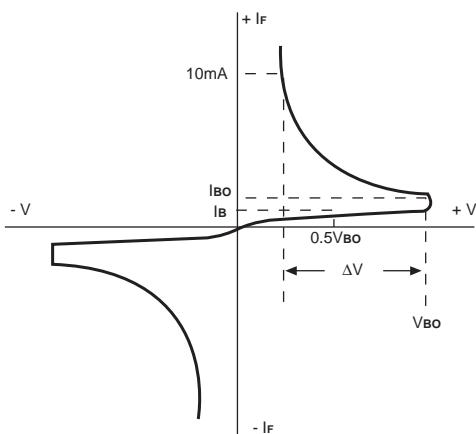


FIG. 1-POWER DISSIPATION VERSUS AMBIENT TEMPERATURE(MAXIMUM VALUES)

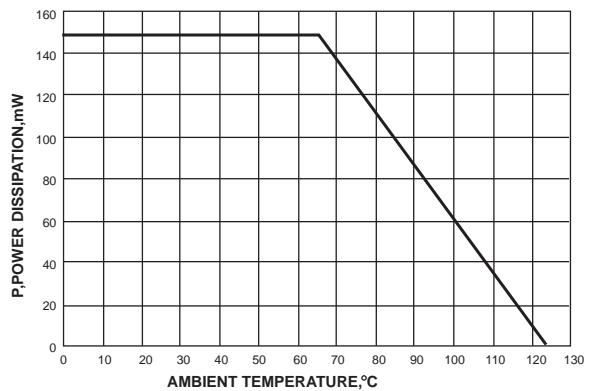


DIAGRAM 2: TEST CIRCUIT OUTPUT VOLTAGE

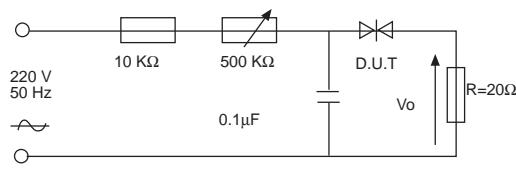


FIG. 2-PEAK PULSE CURRENT VERSUS PULSE DURATION (MAXIMUM VALUES)

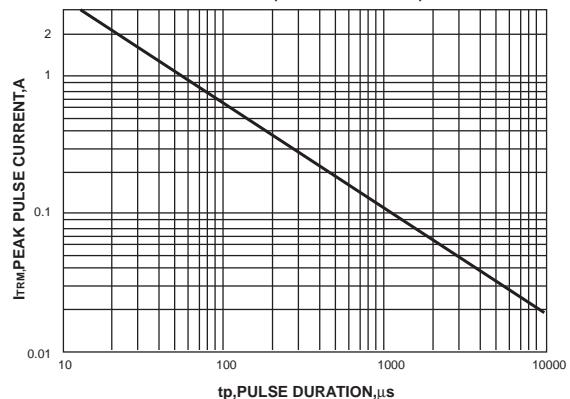


DIAGRAM 3: TEST CIRCUIT SEE DIAGRAM 2.AJUST R FOR $I_P=0.5A$

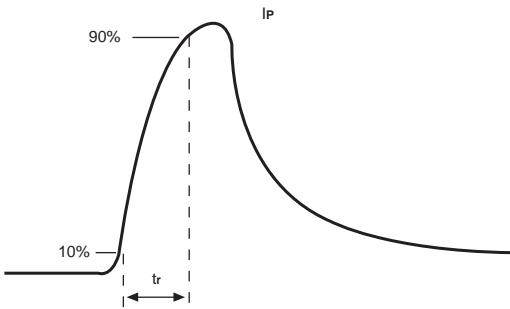


FIG. 3-RELATIVE VARIATION OF V_{BO} VERSUS JUNCTION TEMPERATURE(TYPICAL VALUES)

